



SMD Auto X8G HT150C Flex, Ceramic, 62 pF, 2%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, Automotive Grade, 1210, 1.5 mm



General Information			
Series	SMD Auto X8G HT150C Flex		
Style	SMD Chip		
Description	SMD, MLCC, High Temperature, Ultra-Stable, Automotive Grade		
Features	High Temperature, Ultra-Stable, Automotive Grade		
RoHS	Yes		
Termination	Flexible Termination		
Marking	No		
Qualifications	AEC-Q200		
AEC-Q200	Yes		
Typical Component Weight	30 mg		
Shelf Life	78 Weeks		
MSL	1		

Dimensions	
Chip Size	1210
L	3.3mm +/-0.4mm
W	2.6mm +/-0.3mm
Т	0.78mm +/-0.20mm
S	1.5mm MIN
В	0.6mm +/-0.25mm

·	0.7 0.1			
S	1.5mm MIN			
В	0.6mm +/-0.25mm			
Packaging Specifications				
Packaging	T&R, 180mm, Plastic Tape			

Packaging Quantity

4000

Specifications	
Capacitance	62 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	2%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

Aging Ra	ging Rate		0% Loss/Decade Time is 1000 Hou	
Insulatio	sulation Resistar	ance	100 GOhms	

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Generated 05/18/2025 © 2006 - 2025 YAGEO